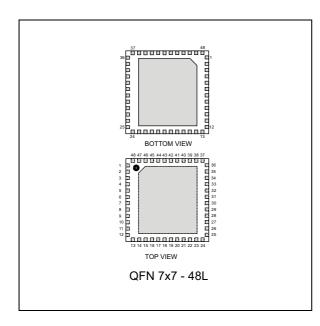


High speed digital input current limiter

Datasheet - production data



Features

- 8 inputs 8-bit SPI output
- · High side input with common ground
- 5 V Voltage regulator
- Package: QFN 7x7 48L
- 30 V reverse polarity capable
- Adjustable current limiters
- LED output for visual status
- Optional: 16-bit mode with parity check, temperature and voltage alarms
- · Daisy chain capable
- Power dissipation: 78 mW per channel

Complies with following standards:

- IEC61000-4-2:
 - ±8 kV contact discharge
 - ±15 kV air discharge
- IEC61000-4-4:
 - ±4 kV

IEC61000-4-5:– Input: ±1 kV

Power supply: ±2.5 kV

Application

- Programmable logic controller and remote input modules
- High speed protected termination for digital input with serialized SPI output
- IEC61131-2 type 1, 2 and 3
- Compliant with EN60947-5-2

Benefits

- · Simplified design due to
 - Built-in over voltage robustness and immune data transfer
 - Compliance with sensors and PLC's standards
- Space saving in cost effective solution with
 - Integrated QFN 7x7 package
 - SPI output reducing opto-couplers quantity
- · Energy efficient solution
 - Energy-less input LED visual status powered by inputs current
 - Low overall dissipation versus discrete

Description

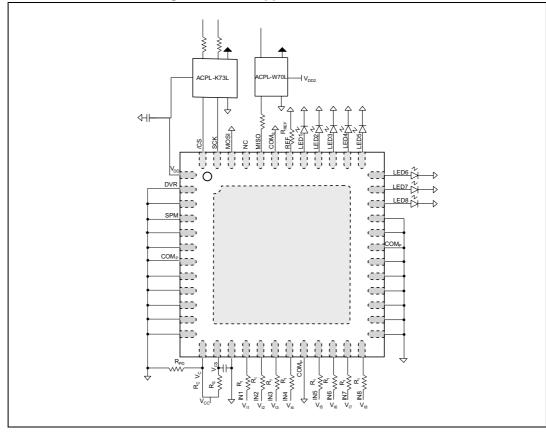
The CLT01-38SQ7 provides an 8-line protected digital input termination with serialized state transfer. This device enhances the I/O module density by cutting the dissipation (78 mW per input) and reducing the count of opto-transistors. Its 6.25 MHz SPI peripheral output serializes the input state transfer to the I/O module controller.

Circuit block diagram 1

DVR For i = 1 to 8 Logic control Input state register Data state register 8 lines MOSI MOSI . ∴ /cs Shift SPM Control state register Power supply Under voltage alarm

Figure 1. circuit block diagram

Figure 2. Basic application schematic



1.1 I/O pin description

Table 1. I/O pin descriptions

Name	Туре	Description	Pin #
INI	Power input	Logic input with current limitation, I = 1 to 8	16, 17, 18, 19, 21, 22, 23, 24
LDI	Power output	LED output driver with current regulation, I = 1 to 8	34, 35, 36, 37, 38, 39, 40, 41
V _C	Power input	24 V sensor power supply	13
V _{CS}	Signal input	24 V sensor power supply sensing input	14
COM _P	Ground	Power ground of power sensor supply	7, 15, 20, 31
V _{DD}	Power output	5 V logic power supply	1
COMS	Ground	Signal ground of logic / output section	43
REF	Signal input	Input current limiter reference setting	42
SPM	Signal input	SPI shift register length selector: -SPM to GND: 16 bits -SPM to VDD: 8 bits	4
/CS	Logic input	SPI chip Select signal	48
SCK	Logic input	SPI serial clock signal	47
MOSI	Logic input	SPI serial data input signal	46
DVR	Logic input	SPI data selector: -DVR to GND: pin 31 = MISO -DVR to VDD: pin 31 = /MISO	2
MISO or /MISO	Logic output	SPI serial data output signal or inverting SPI serial data output signal	44
TAB	Substrate	Exposed pad: connected to die substrate, to be connected to COM _P	TAB
NC		Not connected (or to be connected to COM _P)	3, 5, 6, 8, 9, 10, 11, 12, 25, 26, 27, 28, 29, 30, 32, 33, 45

Circuit block diagram CLT01-38SQ7

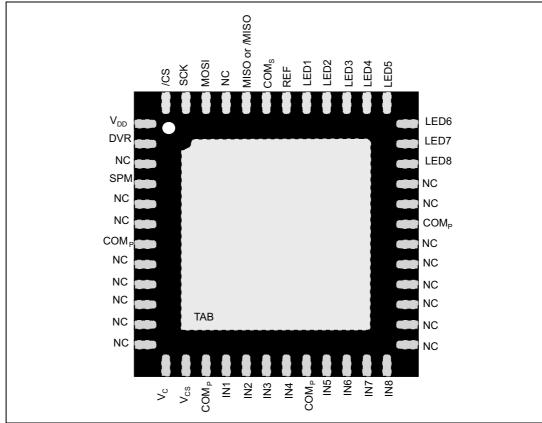


Figure 3. Pinout description of the QFN7x7-48L version (top view)

The package is the QFN7x7-48L exposed pad that improves ground cooling transfer of input dissipation to the printed board.

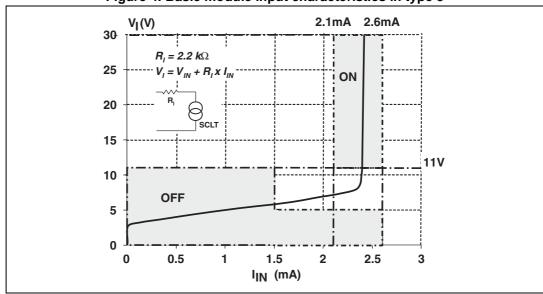


Figure 4. Basic module input characteristics in type 3

2 Characteristic information

Table 2. Absolute maximum ratings

Symbol	Pin	Parameter name	Conditions	Value	Unit
V _{CC}	V _c	Bus power supply DC voltage	$500 \Omega < R_c < 2.2 kΩ$	-0.3 to 35	V
V _C	V _c	CLT01-38SQ7 power supply voltage	$R_c = 0 k\Omega$	-0.3 to 30	V
I _{CC}	V _c	Maximum bus power supply current		15	mA
V _{CS}	V _{CS}	Sensing bus power supply voltage		-0.3 to 6	V
I _{DD}	V_{DD}	Maximum output power supply current	R _c = 500 Ω	12	mA
V _I	INI	Input steady state voltage, I = 1 to 8	$R_I = 2.2 \text{ k}\Omega$	-30 to 35	V
I _{IN}	INI	Input forward current range		-20 to 10	mA
LV _I	SCK /CS MOSI	Logic input voltage		-0.3 to 6	V
T _{stg}	All	Storage temperature range		-40 to 150	°C
T _{amb}	All	Ambient temperature range		-40 to 105	°C



Table 3. Operating conditions

Symbol	Pin	Parameter name	Conditions	Value	Unit
V _{CC}	V _c	Bus power supply steady state voltage	R _c > 500 Ω	15 to 35 ⁽¹⁾	V
V _{DD}	V_{DD}	Internal logic power supply voltage		5	V
I _{DD}	V_{DD}	Internal logic power supply voltage	$R_c > 500 \ \Omega$	10	mA
VI	IN	Input repetitive steady state voltage	$R_{I} = 2.2 \text{ k}\Omega^{(2)}$	-30 to 35	V
V _{LD}	LD _I	Maximum LED output voltage, I = 1 to 8		2.7	V
F _{IN MAX}	IN	Maximum single input frequency	8-bit mode	200	kHz
F _{SCK MAX}		Maximum SPI clock frequency		6.25	MHz
LV	SCK /CS MOSI MISO /MISO	Logic input/output voltages		0 to 5.5	٧
			V _{CC} ≤30 V	-40 to 85	°C
T _{amb}	ALL	Operating ambient temperature range	V _{CC} ≤ 24 V R _{th(j-a)} = 70 °C/W	-40 to 105	°C
Tj		Operating junction temperature range		-40 to 150	°C

^{1. 32} V in DC; 35V during 0.5 s max

Table 4. DC electrical characteristics based on figure 2 application environment

Symbol	Pin	Name	Conditions	Min.	Тур.	Max.	Unit
Input Curr	ent limita	tion					
I _{LIM}	IN	Input limiting current	$V_{IN} = 5.5 \text{ to } 26 \text{ V}$ $R_{I} = 2.2 \text{ k}\Omega$	2.1	2.35	2.6	mA
I _{ON}	LDI	On state LED current	V _I = 11 V	2			mA

^{2.} $V_I = V_{IN} + R_I \times I_{IN}$

Table 5. SPI electrical characteristics (T_j = 25 °C, V_{CC} = 24 V, V_{DD} = 5 V respect to COM ground pin; unless otherwise specified)

Symbol	Pin	Name	Conditions	Min.	Тур.	Max.	Unit
F _{CK}	SCK	Clock frequency				6.25	MHz
T _{CAPTURE}		Minimum data capture time	F _{CK} = 6.25 MHz	2.5			μs
T _{PROPA}		Data transfer/Propagation time	F _{CK} = 6.25 MHz	4			μs
T _S	MOSI	Data setup time	MOSI toggling to SCK rising	25			ns
T _D	MISO	Write out propagation time	SCK falling to MISO toggling, C _{OUT} = 10 pF			50	ns
T _{LD}	SCK	Enable lead time	/CS falling to SCK rising	80			ns
T _{HC}	SCK	Clock hold time	SCK falling to /CS rising	160			ns
T _{DT}	/CS	Transfer delay time	/CS rising to /CS falling			150	ns
T _H	MOSI	Data hold time	SCK rising to MOSI toggling	25			ns
T _{DIS}	MISO	Data output disable time	/CS rising to MISO disabled			200	ns
LV _{IH}	MOSI SCK /CS	Logic input high voltage	Share of V _{DD}			70	%
LV _{IL}		Logic input low voltage	Share of V _{DD}	30			%
LV _{OH}	/MISO MISO	Logic output high voltage	I _{OH} = 3mA	4	4.75		V
LV _{OL}		Logic output low voltage	I _{OL} = 3mA		0.25	1	V
T _{RO} , T _{FO}	MISO /MISO	MISO signal fall/rise time	I _{MISO} = 3mA		20		ns
T _A	MISO	Output access time	/CS falling to MISO toggling		40	80	ns
DuCy	SCK	Clock duty cycle		25		75	%

Figure 5. Time diagram

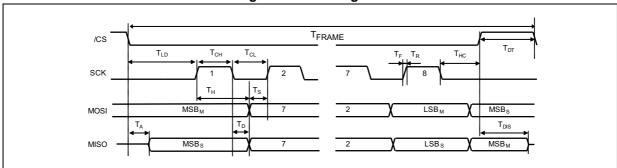


Table 6. Electromagnetic compatibility ratings

Symbol	Pin	Parameter name ⁽¹⁾	Value	Unit
V_{PPB}	V _I	Peak pulse voltage burst, IEC61000-4-4 ⁽²⁾	4	KV
V _{PP}	VI	Peak pulse voltage surge, IEC61000-4-5	1	kV
V _{PP}	V _{CC}	Peak pulse voltage surge, IEC61000-4-5	2.5	kV
V _{ESD}	V _{IN}	ESD protection, IEC 61000-4-2, per input – air – contact	15 8	kV

^{1.} Test set-up, see application Figure 2.



^{2.} See AN3031.

3 Functional description

3.1 Operation of the CLT01-38SQ7 with the SPI bus ($C_{POL} = 0$, $C_{PHA} = 0$)

The SPI bus master controller manages the data transfer with the chip select signal /CS and controls the data shift in the register with the clock SCK signal.

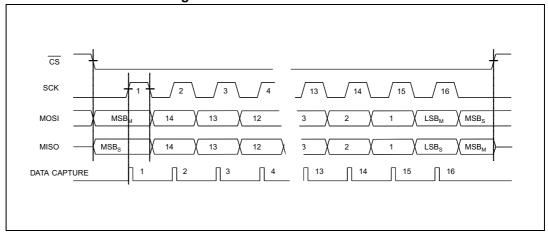


Figure 6. Serial data format frame

The transfer of the CLT01-38SQ7 input states in the SPI registers starts when the Chip Select /CS signal falls and ends when this /CS is rising back.

The transfer of data out of the CLT01-38SQ7 slave MISO output starts immediately when the chip select /CS goes low.

Then, the input MOSI is captured and presented to the shift register on each rising edge of the clock SCK. And the data are shifted in this register on each falling edge of the serial clock SCK, the data bits being written on the output MISO with the most significant bit first.

3.1.1 The serial data Input MOSI

This input signal MOSI is used to shift external data bits into the CLT01-38SQ7 register from the most significant MSB bit to the lower significant one LSB. The data bits are captured by the CLT01-38SQ7 on the rising edge of the serial clock signal SCK.

3.2 The SPI data transfer operation

3.2.1 The SPI data frame

Depending on the biasing of the SPM pin, the data frame is 8-bits or 16-bits. The selected structure of the SPI is a 16-bit word in order to be able to implement the input state data and some control bits such as the UVA alarm, the 4 checksum bits and the two low & high state stop bits.

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3.2.2 The SPI data transfer

The CLT01-38SQ7 transfers its 16 data bits through the SPI within one chip select Hi-Lo-Hi sequence. So, this length defines the minimum length that the shift register of the SPI master controller is able to capture: 16 bits.

The *Table 7* shows the 16-bit mode way the data are transferred starting from the data bits, the control bits and ending by a stop bit.

Table 7. SPI data transfer organization versus CLT input states with SPM = 0

Bit #	LSB	Bit 1	Bit 2	Bit 3	Bit 4	Bit 5	Bit 6	Bit 7
Control	High	Low	PC4	PC3	PC2	PC1	/OTA	/UVA

Last out

Bit #	Bit 8	Bit 9	Bit 10	Bit 11	Bit 12	Bit 13	Bit 14	MSB
Data	IN 1	IN 2	IN 3	IN 4	IN 5	IN 6	IN 7	IN 8

First out

3.3 Control bit signals of the SPI transferred data frame

3.3.1 The power bus voltage monitoring

The UVA circuit generates the alarm /UVA that is active low when the power bus voltage is lower than the activation threshold V_{CON} , 17 V typical, and it is disabled high when the power bus voltage rises above the threshold V_{COFF} , 18 V typical.

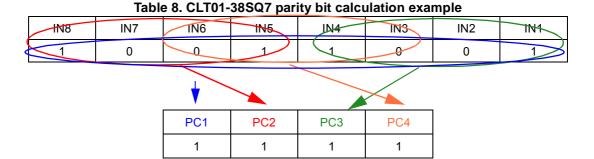
3.3.2 The over temperature alarm

The alarm signal /OTA is enabled, low state active, when the junction temperature is higher than the activation threshold T_{ON} , 150 °C typical, and it is disabled when the junction temperature falls below the threshold T_{OFF} , 140°C typical.

3.3.3 The parity checksum bits calculation and transfer

The aim of the parity checksum bit is to detect one error in the transferred SPI word. Several parity checksum bits are generated and transmitted through the SPI on the control bit #2 to #5.

In order to calculate parity bit, "exclusive NOR" operations are performed as follow:



3.4 Loss of V_{CC} power supply

The operation of the CLT01-38SQ7 is extended below the levels required in the IEC 61131-2 standard to allow the implementation of the under voltage alarm UVA as described the SPI control bit section.

If there is no more power feeding on the V_{CC} input, the CLT01-38SQ7 chip goes to sleep mode, and the MISO output is forced in low state during SPI transfer attempt. The last SPI control data bit is a stop bit placed normally in high state all time: the loss of power supply is detected by checking its state: if low, the output is disabled by the internal power reset POR.

This POR signal is active in low state when V_C is less than 9V or the internal power supply V_{DD} is less than 3.25 V.

Table 9. Logic state of the SPI output versus the power loss signal POR and the SPI chip select /CS

POR	/cs	MISO	/MISO	SPI status
1	1	Z	Z	Normal with no communication
1	0	1	0	Normal with communication
1	0	0	1	Normal with communication
0	1	Z	Z	Power loss with no communication
0	0	0	1	Power loss with communication attempt

Power supply status

Loss of power UV Alarm Power good $V_{C} = V_{CC} - R_{C} \times (I_{C} + I_{DD})$ UVA $V_{C} = V_{CC} - R_{C} \times (I_{C} + I_{DD})$ IEC61131-2 le vel

POR $V_{C} = V_{C} - R_{C} \times (I_{C} + I_{DD})$ UVA $V_{C} = V_{C} - R_{C} \times (I_{C} + I_{DD})$ IEC61131-2 le vel $V_{C} = V_{C} - R_{C} \times (I_{C} + I_{DD})$ UVA $V_{C} = V_{C} - R_{C} \times (I_{C} + I_{DD})$ $V_{C} = V_{C} - R_{C} \times (I_{C} + I_{DD})$ IEC61131-2 le vel $V_{C} = V_{C} - R_{C} \times (I_{C} + I_{DD})$ $V_{C} = V_{C} - R_{C} \times (I_{C} + I_{DD})$ IEC61131-2 le vel $V_{C} = V_{C} - R_{C} \times (I_{C} + I_{DD})$

Figure 7. Logic status of the SCLT3-8BQ7 power supply



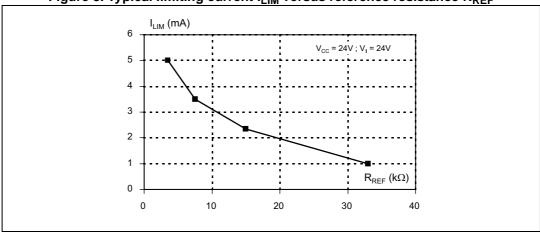


Figure 9. Typical limiting current I_{LIM} versus junction temperature T_J

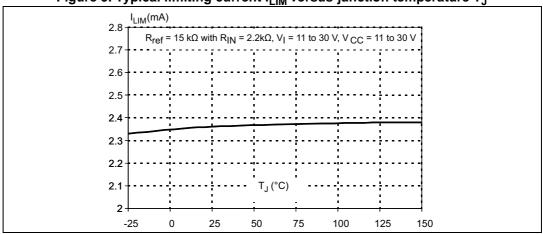
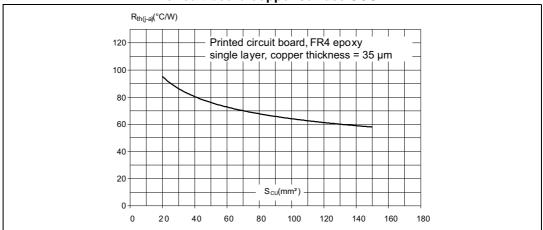


Figure 11. Variation of junction to ambient thermal resistance $R_{\text{th(j-a)}}$ versus printed circuit board copper surface SCU



CLT01-38SQ7 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

4.1 QFN7x7-48L package information

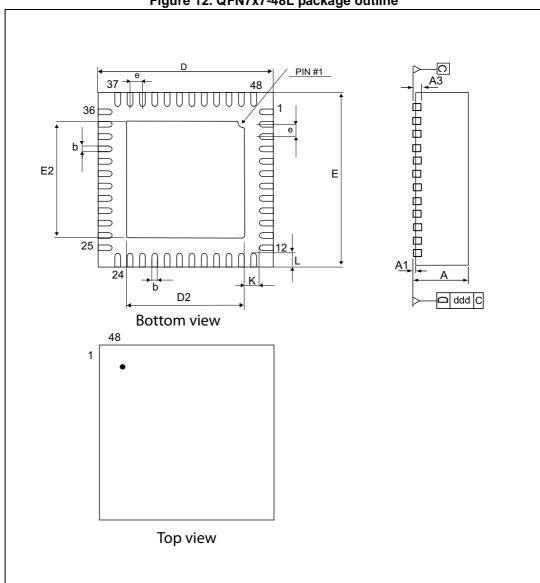


Figure 12. QFN7x7-48L package outline

Package information CLT01-38SQ7

Table 10. QFN7x7-48L package mechanical data

			Dimer	nsions		
Ref.		Millimeters			Inches ⁽¹⁾	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.80	0.90	1.00	0.0315	0.0354	0.0394
A1		0.02	0.05		0.0008	0.0020
A3		0.203			0.008	
b	0.18	0.25	0.30	0.0071	0.0100	0.0118
D		7.00			0.275	
Е		7.00			0.275	
е		0.50			0.019	
D2	5.00	5.15	5.25	0.197	0.203	0.206
E2	5.00	5.15	5.25	0.197	0.203	0.206
K	0.20			0.008		
L	0.30	0.40	0.50	0.011	0.015	0.019

^{1.} Values in inches are converted from mm and rounded to 4 decimal digits.

CLT01-38SQ7 Ordering information

5 Ordering information

Figure 13. Ordering information scheme

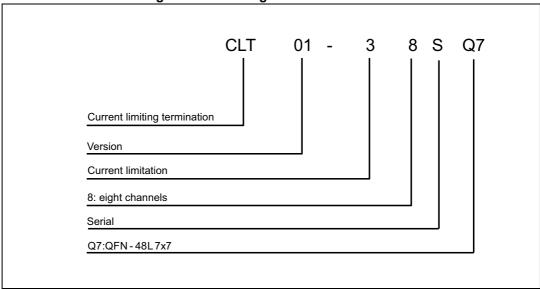


Table 11. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
CLT01-38SQ7	CLT01-38SQ7	QFN7x7-48L	114 mg	2500	Tape and reel

6 Revision history

Table 12. Document revision history

Date	Revision	Changes
31-July-2015	1	Initial release.

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